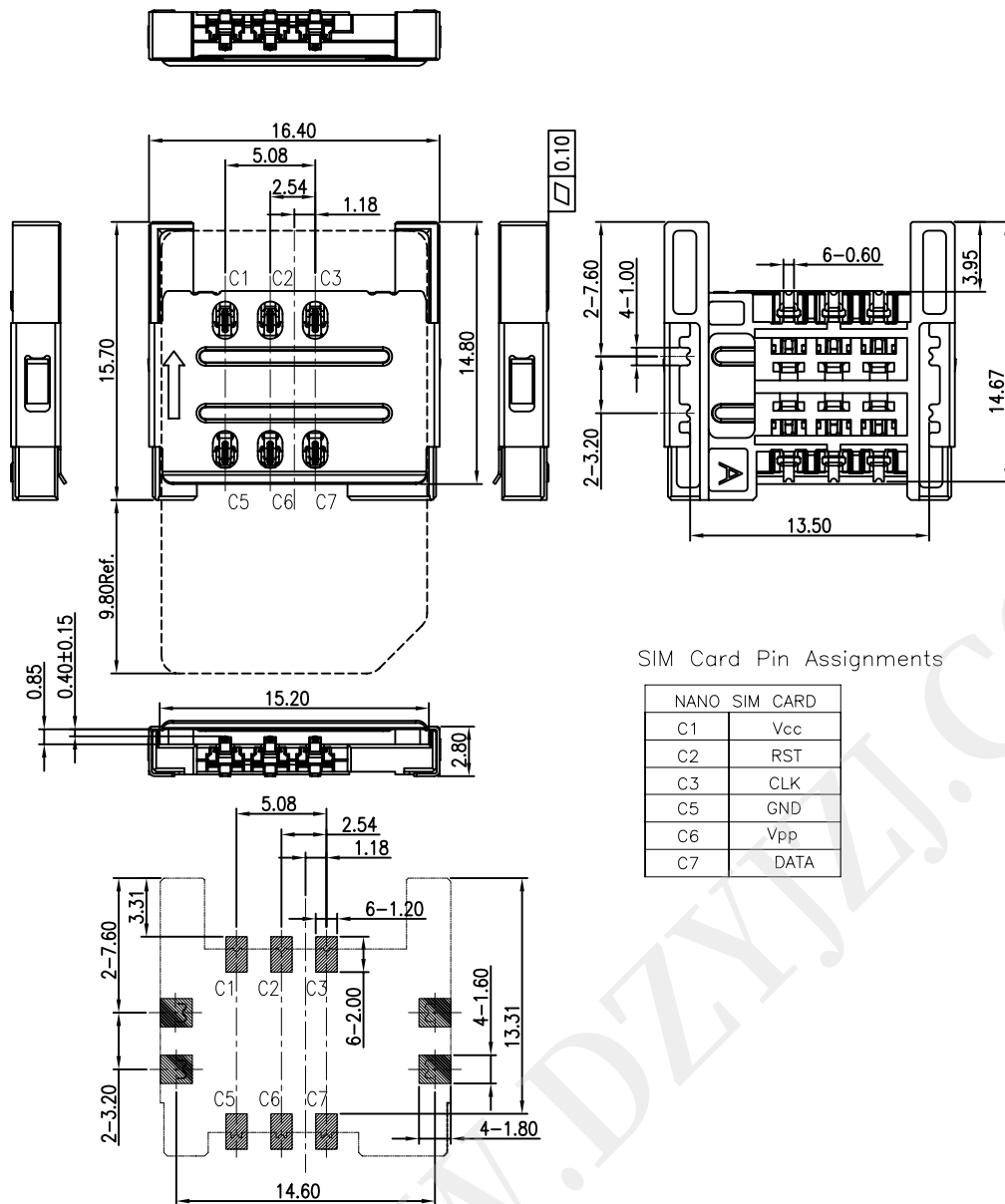
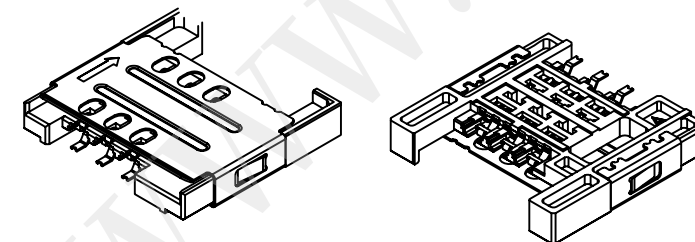




SIM Card Pin Assignments

NANO SIM CARD	
C1	Vcc
C2	RST
C3	CLK
C5	GND
C6	Vpp
C7	DATA



NOTES :

1.Property:

- 1.1 Current Rating :1.0A AC/DC
- 1.2 Voltage Rating :50VRMS
- 1.3 Dielectric Withstanding Voltage: AC 500V r.m.s.
- 1.4 Insulation Resistance:1000MΩ minimum.
- 1.5 Contact Resistance:80mΩ maximum
- 1.6 Operating Temperature:-25°C~85°C

Name	Material	Electroplating
Plastic Housing	LCP Black	
Shell	SUS304 T=0.15	50u" MIN NICKEL UNDERPLATED, GOLD FLASH PLATED SOLDER TAILS.
CONTACT Material	C5210R-EH T=0.12	50U" MIN NICKEL UNDERPLATED, 1U" MIN GOLD PLATED OVER ALL



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TOLERANCE: XX ±0.30 XX ±0.25 XXX ±0.15 X° ±2° X.X° ±0.5° UNIT: mm [inch] SCALE:1:1 SIZE: A4	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: SIM 6PIN 连桥带档 2.8H
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HVC309-SIM06-280
	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
			DRAW NO: HVC-2204251010 SHEET NO. 1 OF 1

RECOMMENDER PCB LAYOUT
TOLERANCE UNLESS OTHERWISE IS ±0.05

PAD AREA
 KEEP OUT AREA
 GND PATTERN ONLY